# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6936472

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
SEQUENCE:	3

## **CONVEYING PARTY DATA**

Name	Execution Date
SUNEDISON SEMICONDUCTOR LIMITED	06/06/2018
MEMC JAPAN LTD	06/06/2018
MEMC ELECTRONIC MATERIALS S.P.A	06/06/2018

#### **RECEIVING PARTY DATA**

Name:	GLOBALWAFERS CO., LTD.
Street Address:	NO. 8. INDUSTRIAL EAST ROAD
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	R.O.C.

## **PROPERTY NUMBERS Total: 1**

Property Type	Number					
Application Number:	16237071					

### **CORRESPONDENCE DATA**

**Fax Number:** (314)612-2307

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 3146215070

**Email:** uspatents@armstrongteasdale.com

Correspondent Name: RICHARD A. SCHUTH

Address Line 1: ARMSTRONG TEASDALE LLP
Address Line 2: 7700 FORSYTH BLVD., SUITE 1800

Address Line 4: ST. LOUIS, MISSOURI 63105

ATTORNEY DOCKET NUMBER: 28744-4953 (150019A.2)

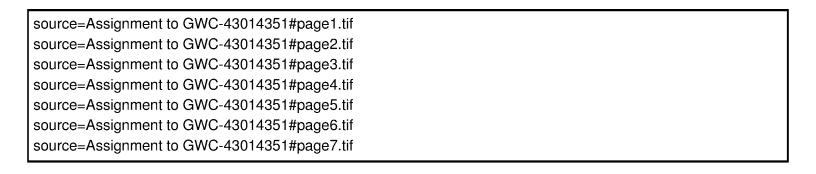
NAME OF SUBMITTER: RICHARD A. SCHUTH

SIGNATURE: /Richard A. Schuth/

DATE SIGNED: 09/27/2021

**Total Attachments: 7** 

PATENT REEL: 057604 FRAME: 0616



PATENT REEL: 057604 FRAME: 0617

#### ASSIGNMENT

This Assignment is made by and among SunEdison Semiconductor Limited, a company organized and existing under the laws of Singapore ("SSL"), MEMC Japan Limited, a company organized and existing under the laws of Japan ("MEMC Japan"), and MEMC Electronic Materials, S.P.A., a company organized and existing under the laws of Italy ("MEMC EM", and collectively with SSL and MEMC Japan, the "Assignors"), and GlobalWafers Co., Ltd., a company organized and existing under the laws of Taiwan and having its registered address at No. 8. Industrial East Road, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C. (hereinafter referred to as "Assignee");

WHEREAS, on December 31, 2016, Assignors entered into certain IP Transfer Agreements with Assignee;

WHEREAS, the parties hereto desire to memorialize, *nunc pro tunc*, the assignment and ownership of all Assigned IP (defined below) for, among other things, recordal purposes with certain patent administration bodies, such as the United States Patent and Trademark Office; and

WHEREAS, Assignors acknowledge that payment in full from Assignee for all Assigned IP has heretofore been paid.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignors have agreed to and do hereby sell, assign and transfer, and confirm the sale, assignment and transfer, unto Assignee all of their rights, title and interest throughout the world, including without limitation, the right to sue and recover for any past infringements, in and to the Listed IP, any other applications (including provisional, non-provisional, divisional, continuing, or reissue applications) based in whole or in part on any Listed IP, any corresponding patent or patent applications filed in any country based in whole or in part on, and/or claiming priority from, any Listed IP, any patents (including extensions thereof) of any country based in whole or in part on, and/or claiming priority from, any Listed IP, and all of the inventions described in the Listed IP and all of the aforementioned patents and patent applications (all of the foregoing, collectively, the "Assigned IP");

TO BE HELD AND ENJOYED by said Assignee, its successors and assigns, as fully and entirely as the Assigned IP would have been held and enjoyed by Assignors had no assignment of said interest been made.

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EACH ASSIGNOR hereby agrees that it will do, execute and deliver, or will cause to be done, executed and delivered, all such further lawful acts, transfers, assignments and conveyances, powers of attorney and assurances for the better assuring, conveying and confirming unto Assignee, all of such Assignor's rights, title and interest in and to the Assigned IP hereby transferred, assigned and conveyed, as Assignee may reasonably require.

[Signature Pages Follow]

IN WITNESS WHEREOF, the undersigned have caused these presents to be executed by their respective officers thereunto duly authorized this \_\_\_\_\_\_ day of \_\_\_\_\_\_\_\_, 2018.

Assignor:

SUNEDISON SEMICONDUCTOR LIMITED

By:

Name: Paul Markowitz

Title:

Director of Intellectual Property

STATE OF\_\_\_

COUNTY OF St. Charles

On this \_\_\_\_\_\_\_\_, day of \_\_\_\_\_\_\_\_\_\_, 2018, before me, a Notary Public, personally appeared Paul Markowitz, an officer of SUNEDISON SEMICONDUCTOR LIMITED, known to me to be the person who executed the within Assignment, and who did state that said instrument was signed on behalf of said company, and acknowledged to me that he executed the same for the purposes therein stated.

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal the date and year last above written.

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My Commission Expires:

July 20, 2018

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Assignor:

MEMC JAPAN LTD

Name: Paul Markowitz

Title:

Director of Intellectual Property

COUNTY OF 1. Charles

On this \_\_\_\_\_\_\_, 2018, before me, a Notary Public, personally appeared Paul Markowitz, an officer of MEMC JAPAN/LTD, known to me to be the person who executed the within Assignment, and who did state that said instrument was signed on behalf of said company, and acknowledged to me that he executed the same for the purposes therein stated.

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal the date and year last above written.

My Commission Expires:

July 20, 2018

Commissioned for St. Charles County
My Commission Expires July 20, 2018

Assignor:

MEMC ELECTRONIC MATERIALS S.P.A.

By:

Name: Paul Markowitz

Title:

Director of Intellectual Property

STATE OF Missouri

On this \_\_\_\_\_\_\_\_, day of \_\_\_\_\_\_\_\_\_\_, 2018, before me, a Notary Public, personally appeared Paul Markowitz, an officer of MEMC ELECTRONIC MATERIALS S.P.A., known to me to be the person who executed the within Assignment, and who did state that said instrument was signed on behalf of said company, and acknowledged to me that he executed the same for the purposes therein stated.

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal the date and year last above written.

My Commission Expires:

July 20, 2018

For and on behalf of GlobalWafers Co., Ltd.

Assignee:

GLOBALWAFERS CO., LTD.

By:

Name: Paul Markowitz

Title:

Director of Intellectual Property

COUNTY OF St. Charles

On this \_\_\_\_\_ day of \_\_\_\_ , 2018, before me, a Notary Public, personally appeared Paul Markowitz, an officer of GLOBALWAFERS CO., LTD., known to me to be the person who executed the within Assignment, and who did state that said instrument was signed on behalf of said company, and acknowledged to me that he executed the same for the purposes therein stated.

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal the date and year last above written.

My Commission Expires:

July 20, 2018

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PROCESS AND PLANT FOR THE PURIFICATION OF TRICHLOROSILANE AND SILICON TETRACHLORIDE  AND SILICON TETRACHLORIDE	PROCESS AND PLANT FOR THE PURIFICATION OF TRICHLOROSILANE KR 10-2007-7013735 18-Jun-2007 AND SILICON TETRACHLORIDE	PROCESS AND PLANT FOR THE PURIFICATION OF TRICHLOROSILANE DE 05813212.7 19-May-2007 AND SILICON TETRACHLORIDE	ATION US 13/606953 7-Sep-2012	US 13/014532 26-Jan-2011	PROCESS AND PLANT FOR THE PURIFICATION OF TRICHLOROSILANE TW 095106046 2-Mar-2006 AND SILICON TETRACHLORIDE	PROCESS AND PLANT FOR THE PURIFICATION OF TRICHLOROSILANE SG 201303855-9 17-May-2013 AND SILICON TETRACHLORIDE	ND	THERMALLY STABLE CHARGE TRAPPING LAYER FOR USE IN MANUFACTURE OF SEMICONDUCTOR- ON-INSULATOR STRUCTURES  THERMALLY STABLE CHARGE US 15/557503 12-Sep-2017 20	JST US 15/358589 22-Nov-2016	CRYSTAL PULLING SYSTEMS AND METHODS FOR PRODUCING MONOCRYSTALLINE INGOTS WITH REDUCED EDGE BAND DEFECTS  15/297853 19: Oct-2016 20	METHODS AND SYSTEM FOR CONTROLLING A SURFACE PROFILE US 15/247099 25-Aug-2016 29 OF A WAFER	MANUFACTURING METHOD OF SMOOTHING A SEMICONDUCTOR US 15/775924 SURFACE	MANUFACTURING METHOD OF SMOOTHING A SEMICONDUCTOR TW 107115498 8-May-2018 SURFACE	TITLE Country Application Filing Date
		1812343	2012-0325645	2011-0114469	1472486	0191588	2017-0107639	2018-0047614	2017-0145587	2017-0107639	2018-0056545			Number
		1-Aug-2007	27-Dec-2012	19-May-2011	11-Feb-2015	31-Jul-2013	20-Apr-2017	15-Feb-2018	25-May-2017	20-Apr-2017	1-Mar-2018			Date
2393991	10-0981813	602005049326.3-08	8691055	8282792	1472486	0191588								Number
10-Jul-2010	6-Sep-2010	11-May-2016	8-Apr-2014	9-Oct-2012	11-Feb-2015	22-Dec-2015								Date

PATENT
RECORDED: 09/27/2021 REEL: 057604 FRAME: 0624